



DMN95H2D2HCTI

N-CHANNEL ENHANCEMENT MODE MOSFET

Product Summary

BV _{DSS}	R _{DS} (ON)	I _D T _C = +25°C	
950V	2.2Ω@V _{GS} = 10V	6A	

Description

This new generation complementary dual MOSFET features low onresistance and fast switching, making it ideal for high efficiency power management applications.

Applications

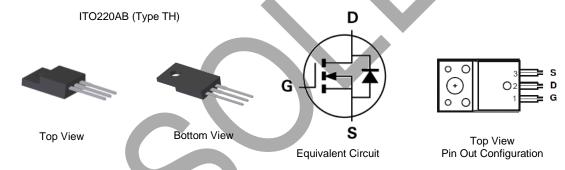
- Motor controls
- Backlighting
- DC-DC converters
- Power management functions

Features

- Low Input Capacitance
- High BV_{DSS} Rating for Power Application
- Low Input/Output Leakage
- Lead-Free Finish; RoHS Compliant (Notes 1 & 2)
- Halogen and Antimony Free. "Green" Device (Note 3)
- For automotive applications requiring specific change control (i.e. parts qualified to AEC-Q100/101/104/200, PPAP capable, and manufactured in IATF 16949 certified facilities), please contact us or your local Diodes representative. https://www.diodes.com/quality/product-definitions/

Mechanical Data

- Package: ITO220AB
- Package Material: Molded Plastic, "Green" Molding Compound, UL Flammability Classification Rating 94V-0
- Terminals: Matte Tin Finish Annealed over Copper Leadframe. Solderable per MIL-STD-202, Method 208 (3)
- Terminal Connections: See Diagram Below
- Weight: 1.85 grams (Approximate)



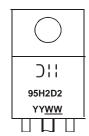
Ordering Information (Note 4)

Part Number	Package		Packing		
Part Number		Fackage	Qty.	Carrier	
DMN95H2D2HCTI		ITO220AB (Type TH)	50 Pieces	Tube	

Notes:

- 1. EU Directive 2002/95/EC (RoHS), 2011/65/EU (RoHS 2) & 2015/863/EU (RoHS 3) compliant. All applicable RoHS exemptions applied.
- 2. See https://www.diodes.com/quality/lead-free/ for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.
- 3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.
- 4. For packaging details, go to our website at https://www.diodes.com/design/support/packaging/diodes-packaging/.

Marking Information





Maximum Ratings (@ $T_A = +25$ °C, unless otherwise specified.)

Characteristic			Value	Unit
Drain-Source Voltage		V_{DSS}	950	V
Gate-Source Voltage			±30	V
ontinuous Drain Current (Note 5) T _C = +25°C		1_	6	۸
Vgs = 10V	$T_C = +100^{\circ}C$	ID	4	A
Pulsed Drain Current (Note 6)			24	Α
Avalanche Current, L = 60mH (Note 7)		las	3.5	Α
Avalanche Energy, L = 60mH (Note 7)		Eas	360	mJ

Thermal Characteristics

Characteristic				Max	Unit
Power Dissipation (Note 5)	$T_C = +25$ °C $T_C = +100$ °C	PD		40 14	W
Thermal Resistance, Junction to Case (Note 5)	$T_C = +25$ °C	R ₀ JC		3.6	°C/W
Operating and Storage Temperature Range		TJ, TSTG	-5	5 to +150	°C

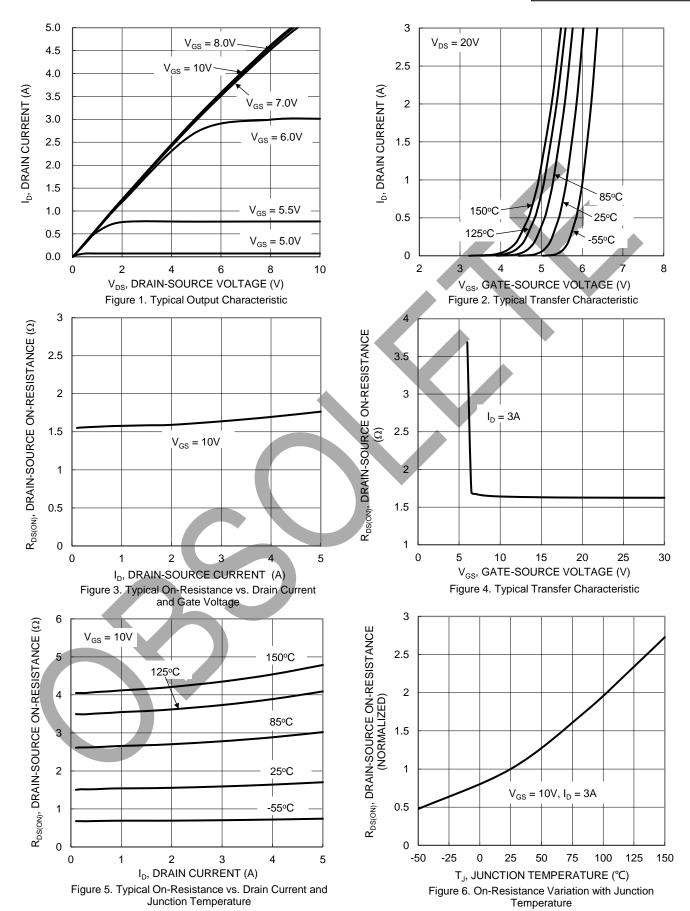
Electrical Characteristics (@TA = +25°C, unless otherwise specified.)

Characteristic	Symbol	Min	Тур	Max	Unit	Test Condition		
OFF CHARACTERISTICS (Note 8)								
Drain-Source Breakdown Voltage	BV _{DSS}	950	_		V	$V_{GS} = 0V, I_D = 250\mu A$		
Zero Gate Voltage Drain Current	I _{DSS}	7		1	μΑ	V _{DS} = 950V, V _{GS} = 0V		
Gate-Source Leakage	lgss	_	_	100	nA	Vgs = ±30V, Vps = 0V		
ON CHARACTERISTICS (Note 8)								
Gate Threshold Voltage	V _{GS(TH)}	3	4	5	V	$V_{DS} = V_{GS}$, $I_D = 250\mu A$		
Static Drain-Source On-Resistance	R _{DS(ON)}		1.7	2.2	Ω	$V_{GS} = 10V, I_D = 3A$		
Diode Forward Voltage	VsD		0.85	1.2	V	V _G S = 0V, I _S = 6A		
DYNAMIC CHARACTERISTICS (Note 7)	DYNAMIC CHARACTERISTICS (Note 7)							
Input Capacitance	Ciss	1	1487	_	pF	V _{DS} = 25V, f = 1MHz, V _{GS} = 0V		
Output Capacitance	Coss		113	_				
Reverse Transfer Capacitance	Crss		1	_				
Gate Resistance	Rg		4.7	_	Ω	$V_{DS} = 0V$, $V_{GS} = 0V$, $f = 1MHz$		
Total Gate Charge	Qg	_	20.3	_		V _{DD} = 720V, I _D = 6A, V _{GS} = 10V		
Gate-Source Charge	Qgs	_	6.4	_	nC			
Gate-Drain Charge	Qgd	_	6.1	_				
Turn-On Delay Time	td(on)	_	39	_		$\begin{split} V_{DD} &= 450 \text{V}, \ V_{GS} = 10 \text{V}, \\ R_g &= 25 \Omega, \ I_D = 6 \text{A} \end{split}$		
Turn-On Rise Time	t _R		49	_	no			
Turn-Off Delay Time	t _{D(OFF)}	_	51	_	ns			
Turn-Off Fall Time	tF	_	31	_				
Body Diode Reverse Recovery Time	t _{RR}	_	607	_	ns	L 60 dl/dt 1000/up		
Body Diode Reverse Recovery Charge	Q _{RR}	_	8.1	_	μC	-I _F = 6A, dI/dt = 100A/μs		

Notes:

- 5. Device mounted on infinite heatsink.6. Device mounted on FR-4 substrate PC board, 2oz copper, with minimum recommended pad layout.7. Guaranteed by design. Not subject to production testing.
- 8. Short duration pulse test used to minimize self-heating effect.







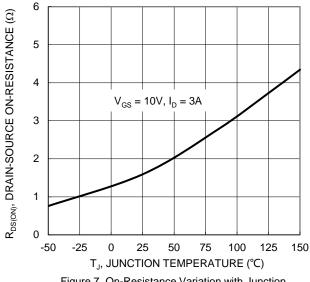


Figure 7. On-Resistance Variation with Junction Temperature

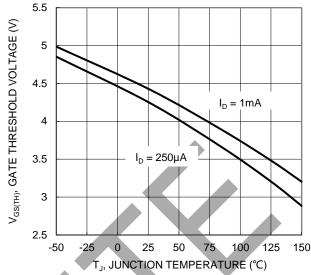


Figure 8. Gate Threshold Variation vs. Junction Temperature

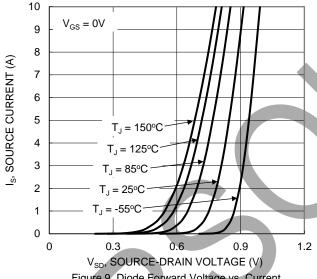


Figure 9. Diode Forward Voltage vs. Current

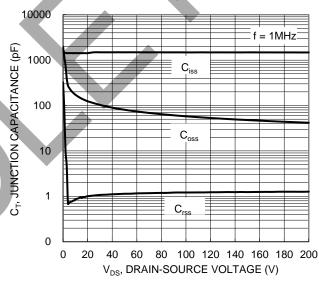


Figure 10. Typical Junction Capacitance

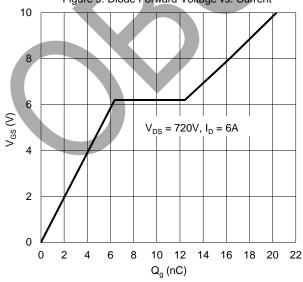


Figure 11. Gate Charge

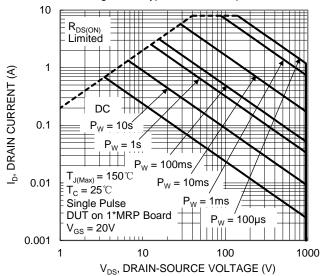


Figure 12. SOA, Safe Operation Area



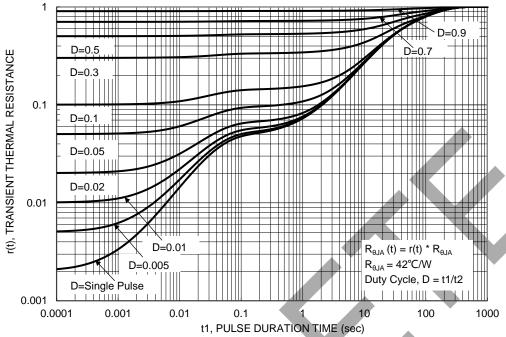


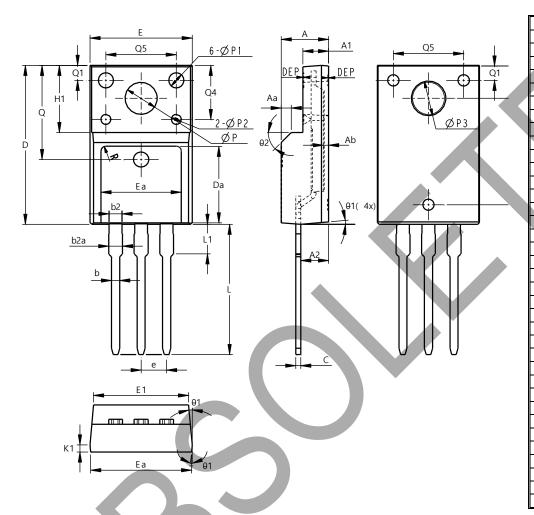
Figure 13. Transient Thermal Resistance



Package Outline Dimensions

Please see http://www.diodes.com/package-outlines.html for the latest version.

ITO220AB (Type TH)



ITO220AB (Type TH)					
Dim	Min	Max	Тур		
A	4.50	4.90	4.70		
A1	2.34	2.74	2.54		
A2	2.63	2.89	2.76		
Aa	1	.00 RE	F		
Ab	0.30	0.60	0.56		
b	0.75	0.90	0.80		
b2	1.23	1.38	1.28		
b2a	1.25	1.45	1.35		
С	0.45	0.60	0.50		
D	15.47	16.27	15.87		
Da	7.55	8.05	7.80		
е	2	.54 BS			
E	9.86	10.46	10.16		
E1	9.26	9.66	9.46		
Ea	7.70	8.30	8.00		
Eb	9.76	10.34	10.04		
H1			F		
L	12.58	13.38	12.98		
L1	2.81	3.05	2.93		
K1	0.65	0.75	0.70		
Q	_		F		
Q1	1.00	2.00	1.50		
Q2	13.50	14.30	13.90		
Q3	3.15	3.45	3.30		
Q4	5.15	5.65	5.40		
Q5	6.70	7.30	7.00		
ØP	3.06	3.40	3.18		
ØP1	1.40	1.60	1.50		
ØP2	0.95	1.05	1.00		
ØP3	3.30	3.60	3.45		
θ1	30	7º	5º		
θ2	-	45°	-		
R	0.50 REF				
DEP		0.15	0.10		
All Dimensions in mm					



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